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March 2014

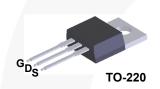
FCP11N60/FCPF11N60

General Description

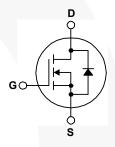
SuperFET® MOSFET is Fairchild Semiconductor's first genera-tion of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switch-ing performance, dv/dt rate and higher avalanche energy. Con-sequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

Features

- 650V @T_i = 150°C
- Typ. Rds(on)=0.32Ω
- Ultra low gate charge (typ. Qg=40nC)
- · Low effective output capacitance (typ. Coss.eff=95pF)
- · 100% avalanche tested
- RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FCP11N60	FCPF11N60	Units	
I _D	Drain Current - Continuous (T _C = 25°C)		11 11*		Α	
	- Continuous (T _C = 100°C)		7	7*	Α	
I _{DM}	Drain Current - Pulsed	(Note 1)	33	33*	Α	
V_{GSS}	Gate-Source Voltage		± 30		V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	340		mJ	
I _{AR}	Avalanche Current	(Note 1)	11		Α	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12.5		mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns	
P _D	Power Dissipation (T _C = 25°C)		125	36	W	
	- Derate above 25°C		1.0	0.29	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300		°C	

^{*} Drain current limited by maximum junction termperature

Thermal Characteristics

Symbol	Symbol Parameter		FCPF11N60	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.0	3.5	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCP11N60	FCP11N60	TO-220	Tube	N/A	N/A	50 units
FCPF11N60	FCPF11N60	TO-220F	Tube	N/A	N/A	50 units
FCPF11N60T	FCPF11N60T	TO-220F	Tube	N/A	N/A	50 units

Floctrical Characteristics

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
D\/	Drain Course Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}, T_J = 25^{\circ}\text{C}$				V
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}, T_J = 150^{\circ}\text{C}$		650		V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.6		V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 11 A		700		V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V		-	1	μΑ
		V _{DS} = 480 V, T _C = 125°C			10	μΑ
I_{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 5.5 A		0.32	0.38	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 5.5 A (Note 4)		9.7		S
Dvnam	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		1148	1490	pF
C _{oss}	Output Capacitance			671	870	pF
C _{rss}	Reverse Transfer Capacitance			63	82	pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1.0 MHz		35		pF
Coss eff.	Effective Output Capacitance	V _{DS} = 0V to 480 V, V _{GS} = 0 V		95		pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V 000 V 1 44 4		34	80	ns
t _r	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, I_D = 11 \text{ A},$		98	205	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 25 \Omega$		119	250	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		56	120	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 11 A,		40	52	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		7.2	7	nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		21	\ \	nC
	Source Diode Characteristics an	nd Maximum Ratings	•			
l _S	Maximum Continuous Drain-Source Diode Forward Current				11	Α
	Maximum Pulsed Drain-Source Diode Forward Current			l	33	Α

\mathbf{Q}_{rr}

 t_{rr}

 V_{SD}

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. $I_{AS} = 5.5A$, $V_{DD} = 50V$, $R_G = 25 \Omega$, Starting $T_J = 25^{\circ}C$ 3. $I_{SD} \le 11A$, $di/dt \le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$ 4. Pulse Test : Pulse width $\le 300\mu s$, Duty cycle $\le 2\%$ 5. Essentially independent of operating temperature

Reverse Recovery Time

Reverse Recovery Charge

Drain-Source Diode Forward Voltage

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 $V_{GS} = 0 \text{ V}, I_{S} = 11 \text{ A}$

 $V_{GS} = 0 V, I_S = 11 A,$

 $dI_F / dt = 100 A/\mu s$

٧

ns

μС

1.4

390

(Note 4)

Typical Characteristics $I_{\scriptscriptstyle D}$, Drain Current [A] l_p, Drain Current [A] V_{DS}, Drain-Source Voltage [V] , Gate-Source Voltage [V] Figure 1. On-Region Characteristics Figure 2. Transfer Characteristics $\begin{array}{c} R_{DS(CM)} \ [\Omega], \\ \text{Drain-Source On-Resistance} \\ \text{70} \\ \text{70} \\ \text{80} \end{array}$ Reverse Drain Current [A] 150°C _R, * Notes : 1. V_{GS} = 0V 2. 250 µs Pulse Tes * Note : T = 25°C 0.4 0.8 1.0 1.2 1.4 I_D, Drain Current [A] V_{SD}, Source-Drain Voltage [V] Figure 3. On-Resistance Variation vs. Figure 4. Body Diode Forward Voltage Variation vs. Source Current **Drain Current and Gate Voltage** and Temperature 6000 V_{DS} = 100V V_{GS}, Gate-Source Voltage [V] Capacitance [pF] 3000 2000

 $V_{_{\rm DS}}$, Drain-Source Voltage [V]

Figure 5. Capacitance Characteristics

1000

* Note : I_D = 11A

 $\mathbf{Q}_{_{\!G^{\!\!\scriptscriptstyle{,}}}}$ Total Gate Charge [nC]

Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

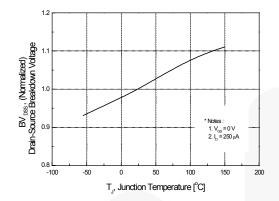


Figure 7. Breakdown Voltage Variation vs. Temperature

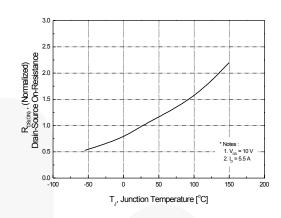


Figure 8. On-Resistance Variation vs. Temperature

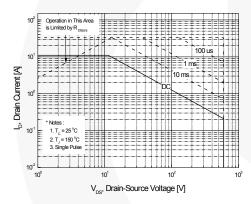


Figure 9-1. Maximum Safe Operating Area for FCP11N60

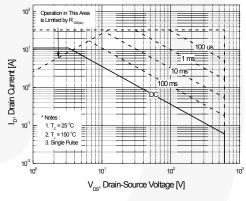


Figure 9-2. Maximum Safe Operating Area for FCPF11N60

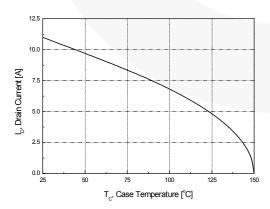


Figure 10. Maximum Drain Current vs. Case Temperature

Typical Characteristics (Continued)

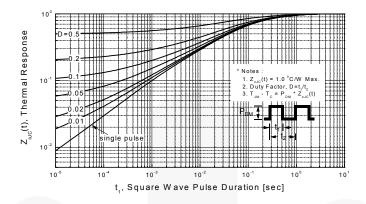


Figure 11-1. Transient Thermal Response Curve for FCP11N60

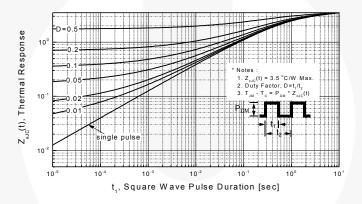


Figure 11-2. Transient Thermal Response Curve for FCPF11N60

Charge

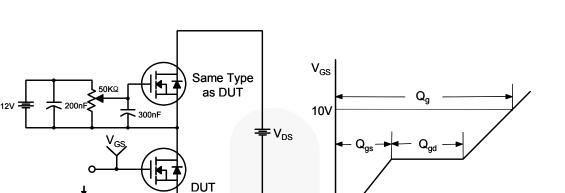


Figure 12. Gate Charge Test Circuit & Waveform

Figure 13. Resistive Switching Test Circuit & Waveforms

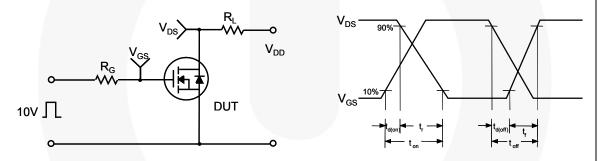
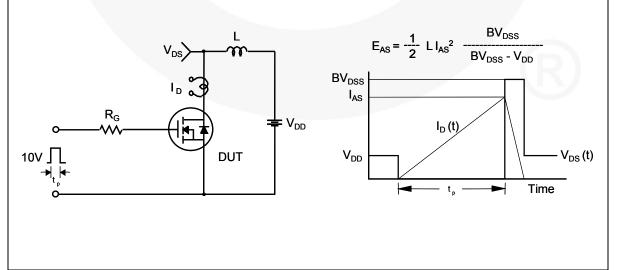
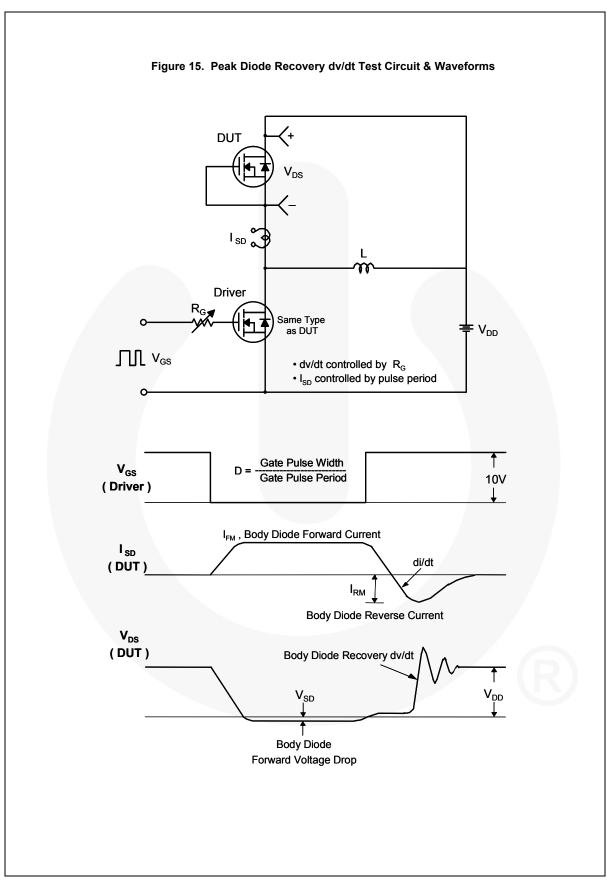


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



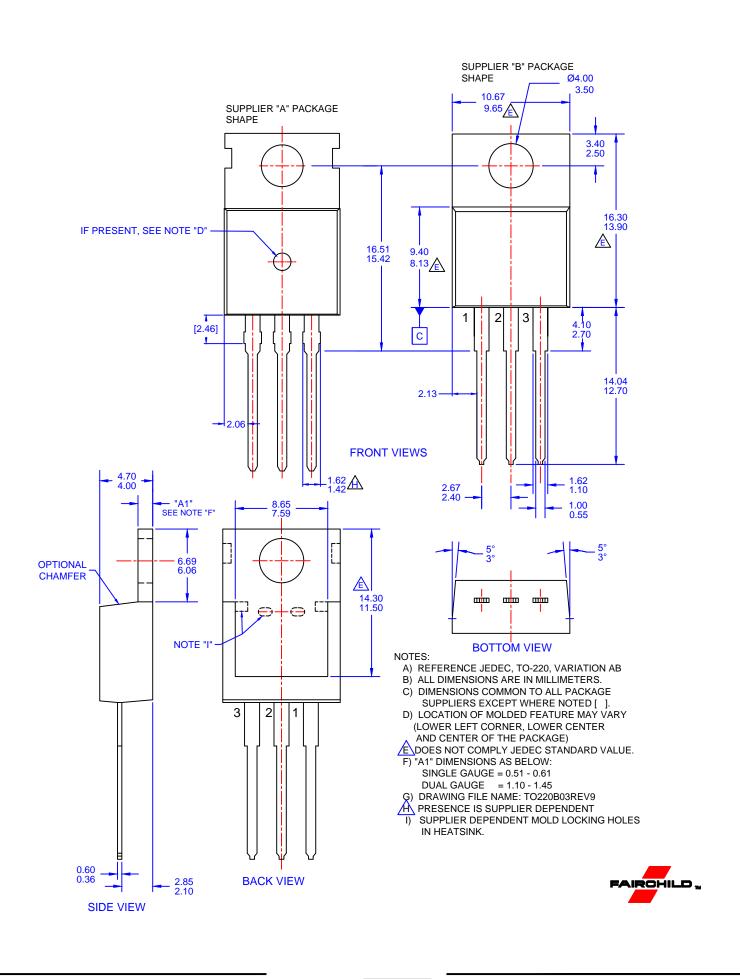
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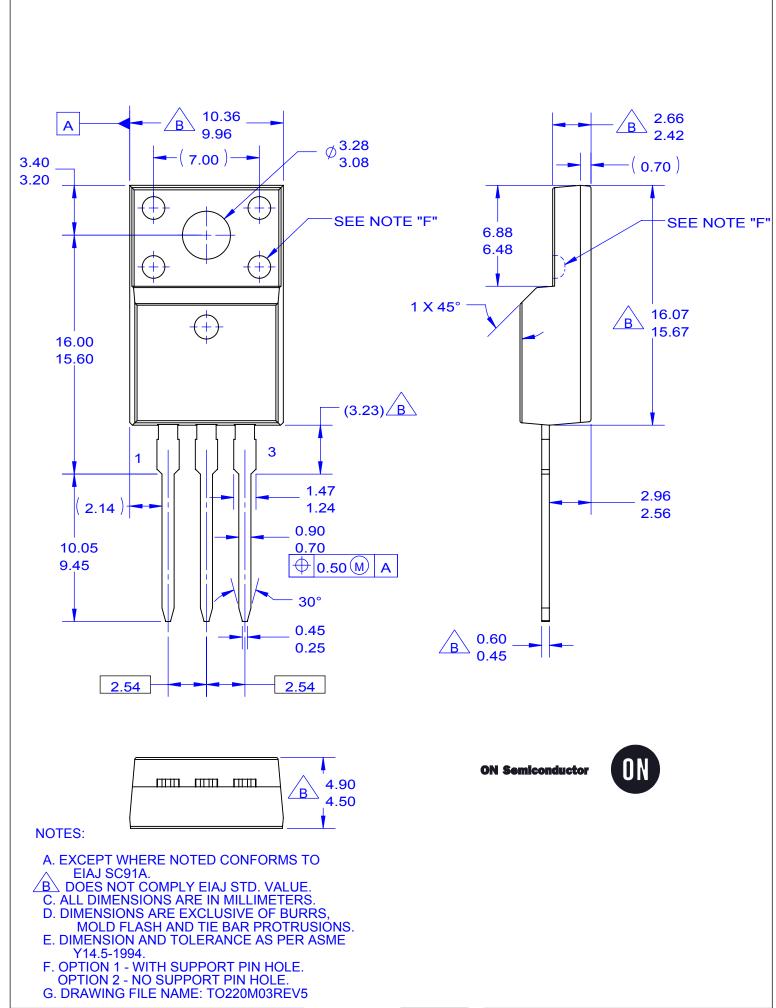
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